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Kind regards,

Team Nexperia



PBSS5220V

20 V, 2 A PNP low V_{CEsat} (BISS) transistor Rev. 03 — 14 December 2009

Product data sheet

Product profile 1.

1.1 General description

PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT666 Surface Mounted Device (SMD) plastic package.

NPN complement: PBSS4220V.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- DC-to-DC conversion
- MOSFET gate driving
- Motor control
- Charging circuits
- Low power switches (e.g. motors, fans)
- Portable applications

1.4 Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|---|--|--------------|-----|-----|------|
| V_{CEO} | collector-emitter voltage | open base | - | - | -20 | V |
| I _C | collector current | | - | - | -2 | А |
| I _{CM} | peak collector current | $t_p \leq 300~\mu s$ | - | - | -4 | А |
| R _{CEsat} | collector-emitter saturation resistance | $I_{C} = -1 \text{ A};$ $I_{B} = -100 \text{ mA}$ | <u>[1]</u> - | 140 | 210 | mΩ |

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$



20 V, 2 A PNP low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2. Pinning

| | 3 | | |
|-----|-------------|--------------------|-------------|
| Pin | Description | Simplified outline | Symbol |
| 1 | collector | | |
| 2 | collector | 6 5 4 | 1, 2, 5, 6 |
| 3 | base | | 3 — |
| 4 | emitter | | |
| 5 | collector | | 4 sym030 |
| 6 | collector | 1 2 3 | 5,55 |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|---------|--|---------|
| | Name | Description | Version |
| PBSS5220V | - | plastic surface mounted package; 6 leads | SOT666 |

4. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PBSS5220V | N7 |

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------------|-----------------------------|-----------------|-----------|------|
| V_{CBO} | collector-base voltage | open emitter | - | -20 | V |
| V_{CEO} | collector-emitter voltage | open base | - | -20 | V |
| V_{EBO} | emitter-base voltage | open collector | - | -5 | V |
| I _C | collector current | | - | -2 | Α |
| I _{CM} | peak collector current | $t_p \leq 300~\mu s$ | - | -4 | Α |
| I _B | base current | | - | -0.3 | Α |
| I _{BM} | peak base current | $t_p \leq 300~\mu s$ | - | -0.6 | Α |
| P _{tot} | total power dissipation | $T_{amb} \le 25 ^{\circ}C$ | <u>[1][4]</u> _ | 0.3 | W |
| | | | [2][4] | 0.5 | W |
| | | | [3][4] | 0.9 | W |
| Tj | junction temperature | | - | 150 | °C |

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

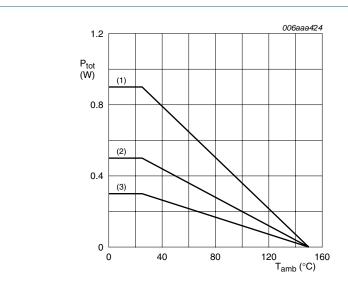
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Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|---------------------|------------|-----|------|------|
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. [1]
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm². [2]
- Device mounted on a ceramic PCB, Al₂O₃, standard footprint. [3]
- Reflow soldering is the only recommended soldering method.



- (1) Ceramic PCB, Al₂O₃, standard footprint
- (2) FR4 PCB, mounting pad for collector 1 cm²
- FR4 PCB, standard footprint

Fig 1. **Power derating curves**

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

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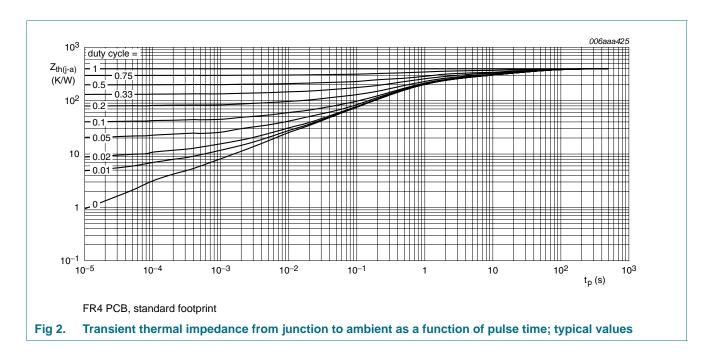
Thermal characteristics 6.

Product data sheet

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--|--|------------|--------|-----|-----|-----|------|
| R _{th(j-a)} thermal resistance from junction to ambient | | | [1][4] | - | - | 410 | K/W |
| | junction to ambient | | [2][4] | - | - | 250 | K/W |
| | | | [3][4] | - | - | 140 | K/W |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | | - | - | 80 | K/W |

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm². [2]
- Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- Reflow soldering is the only recommended soldering method.



20 V, 2 A PNP low V_{CEsat} (BISS) transistor

7. Characteristics

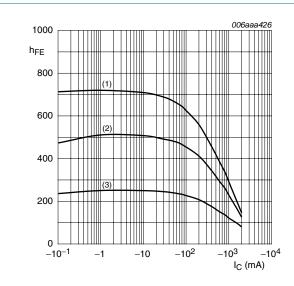
Table 7. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Uni |
|--------------------|---|--|------------|-----|------------|------|-----|
| I _{CBO} | collector-base cut-off | $V_{CB} = -20 \text{ V}; I_E = 0 \text{ A}$ | | - | - | -0.1 | μΑ |
| | current | $V_{CB} = -20 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$ | | - | - | -50 | μΑ |
| I _{CES} | collector-emitter cut-off current | $V_{CE} = -20 \text{ V}; V_{BE} = 0 \text{ V}$ | | - | - | -0.1 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$ | | - | - | -0.1 | μΑ |
| h _{FE} | DC current gain | $V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ mA}$ | | 220 | 495 | - | |
| | | $V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$ | | 220 | 440 | - | |
| | | $V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$ | <u>[1]</u> | 220 | 310 | - | |
| | | $V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}$ | <u>[1]</u> | 155 | 220 | - | |
| | | $V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}$ | [1] | 60 | 120 | - | |
| V_{CEsat} | | $I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$ | | - | -50 | -80 | mV |
| | saturation voltage | $I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$ | <u>[1]</u> | - | -75 | -115 | mV |
| | | $I_C = -1 A$; $I_B = -50 \text{ mA}$ | <u>[1]</u> | - | -155 | -220 | mV |
| | | $I_C = -1 A$; $I_B = -100 \text{ mA}$ | <u>[1]</u> | - | -140 | -210 | mV |
| | | $I_C = -2 \text{ A}; I_B = -100 \text{ mA}$ | [1] | - | -305 | -455 | mV |
| | | $I_C = -2 \text{ A}; I_B = -200 \text{ mA}$ | [1] | - | -265 | -390 | mV |
| R _{CEsat} | collector-emitter saturation resistance | $I_C = -1 A$; $I_B = -100 \text{ mA}$ | [1] | - | 140 | 210 | mΩ |
| V_{BEsat} | base-emitter saturation | $I_C = -1 A$; $I_B = -50 \text{ mA}$ | <u>[1]</u> | - | -0.95 | -1.1 | V |
| | voltage | $I_C = -1 A$; $I_B = -100 \text{ mA}$ | <u>[1]</u> | - | -1 | -1.1 | V |
| V_{BEon} | base-emitter turn-on voltage | $V_{CE} = -5 \text{ V}; I_C = -1 \text{ A}$ | | - | -0.8 | -1 | V |
| t _d | delay time | $I_C = -1 A$; $I_{Bon} = -50 \text{ mA}$; | | - | 8 | - | ns |
| t _r | rise time | $I_{Boff} = 50 \text{ mA}$ | | - | 34 | - | ns |
| t _{on} | turn-on time | | | - | 42 | - | ns |
| ts | storage time | | | - | 140 | - | ns |
| t _f | fall time | | | - | 45 | - | ns |
| t _{off} | turn-off time | | | - | 185 | - | ns |
| f _T | transition frequency | $V_{CE} = -10 \text{ V}; I_{C} = -50 \text{ mA};$ f = 100 MHz | | 150 | 185 | - | MH |
| C _c | collector capacitance | $V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz | | - | 15 | 20 | pF |

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

20 V, 2 A PNP low V_{CEsat} (BISS) transistor



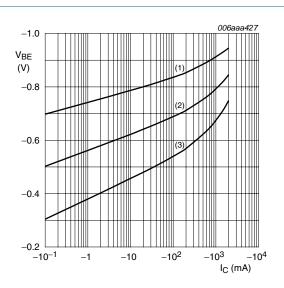
$$V_{CE} = -2 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \,^{\circ}C$$

Fig 3. DC current gain as a function of collector current; typical values



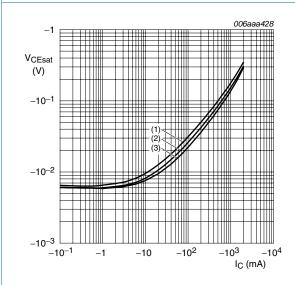
$$V_{CE} = -5 \text{ V}$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 4. Base-emitter voltage as a function of collector current; typical values



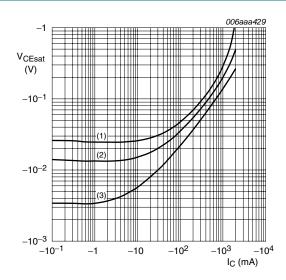
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Collector-emitter saturation voltage as a Fig 5. function of collector current; typical values



$$T_{amb} = 25 \, ^{\circ}C$$

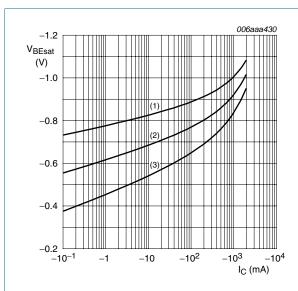
(1)
$$I_C/I_B = 100$$

(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Collector-emitter saturation voltage as a Fig 6. function of collector current; typical values

20 V, 2 A PNP low V_{CEsat} (BISS) transistor



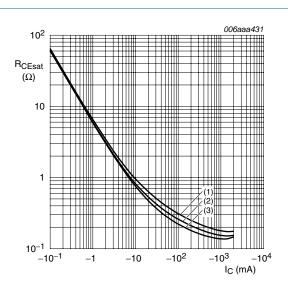
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 7. Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 8. Collector-emitter saturation resistance as a function of collector current; typical values

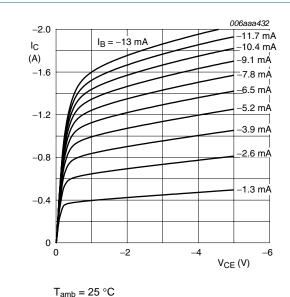
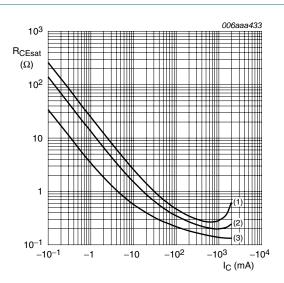


Fig 9. Collector current as a function of collector-emitter voltage; typical values



 $T_{amb} = 25 \, ^{\circ}C$

(1)
$$I_C/I_B = 100$$

(2)
$$I_C/I_B = 50$$

(3)
$$I_C/I_B = 10$$

Fig 10. Collector-emitter saturation resistance as a function of collector current; typical values

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

8. Test information

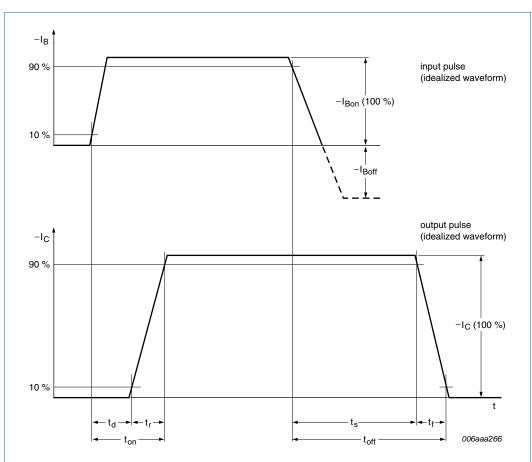
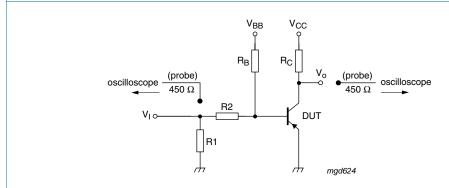


Fig 11. BISS transistor switching time definition

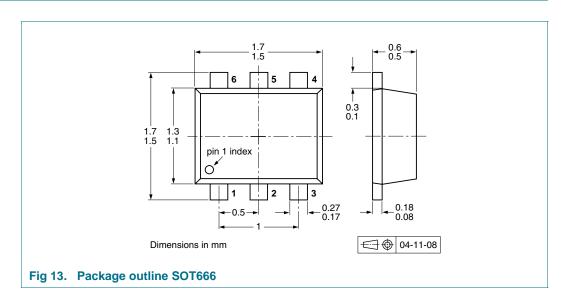


 I_{C} = –1 A; I_{Bon} = –50 mA; I_{Boff} = 50 mA; R1 = open; R2 = 45 $\Omega;$ R_{B} = 145 $\Omega;$ R_{C} = 10 Ω

Fig 12. Test circuit for switching times

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8. Packing methods

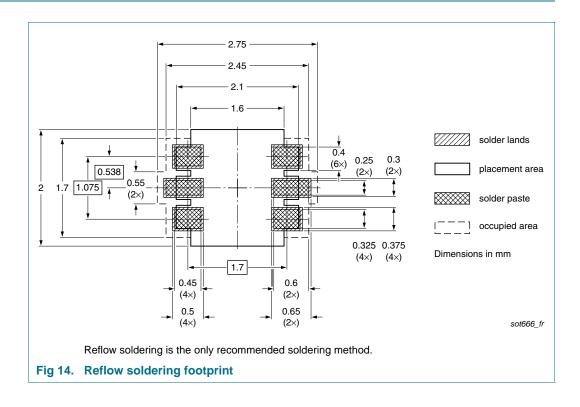
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing quantity | |
|-------------|---------|--------------------------------|------------------|------|
| | | | 4000 | 8000 |
| PBSS5220V | SOT666 | 2 mm pitch, 8 mm tape and reel | - | -315 |
| | | 4 mm pitch, 8 mm tape and reel | -115 | - |

^[1] For further information and the availability of packing methods, see Section 14.

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

11. Soldering



20 V, 2 A PNP low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--|--------------------|---------------|--------------|
| PBSS5220V_3 | 20091214 | Product data sheet | - | PBSS5220V_2 |
| Modifications: | This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content. Figure 14 "Reflow soldering footprint": updated | | | |
| DD005000\/ 0 | 20060208 | Product data sheet | | PP0050001/ 4 |
| PBSS5220V_2 | 20000200 | Product data sneet | - | PBSS5220V_1 |

20 V, 2 A PNP low V_{CEsat} (BISS) transistor

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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20 V, 2 A PNP low V_{CEsat} (BISS) transistor

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